imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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LCA182 Single Pole, Normally Open OptMOS[®] Relay

Parameter	Rating	Units
Blocking Voltage	350	V _P
Load Current	120	mA _{rms} / mA _{DC}
On-Resistance (max)	35	Ω
Input Control Current	0.25	mA

Features

- Very Low Input Control Current (0.25mA)
- 3750V_{rms} Input/Output Isolation
- Low Drive Power Requirements (TTL/CMOS Compatible)
- No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Small 6-Pin Package
- Machine Insertable, Wave Solderable
- Surface Mount, Tape & Reel Version Available

Applications

- Telecommunications
 - Telecom Switching
 - Tip/Ring Circuits
 - Modem Switching (Laptop, Notebook, PocketSize)
 - Hook Switch
 - · Dial Pulsing
 - Ground Start
 - Ringing Injection
- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- · Medical Equipment Patient/Equipment Isolation
- Aerospace
- Industrial Controls

Description

LCA182 is a normally open (1-Form-A) solid state relay that uses optically coupled MOSFET technology to provide 3750V_{rms} of input to output isolation. It features an extremely low input control current of only 0.25mA, which is the lowest available in IXYS Integrated Circuits Division's Solid State Relay family.

Its optically coupled outputs, which use the patented OptoMOS architecture, are controlled by a highly efficient GaAIAs infrared LED.

The LCA182 can be used to replace mechanical relays, and offers the superior reliability associated with semiconductor devices. Because it has no moving parts, it offers faster, bounce-free switching in a more compact surface mount or through-hole package.

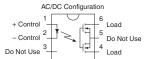
Approvals

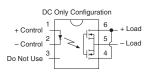
- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1175739
- EN/IEC 60950-1 Certified Component: TUV Certificate B 09 07 49410 004

Ordering Information

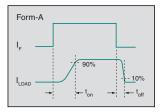
Part #	Description
LCA182	6 Pin DIP (50/Tube)
LCA182S	6 Pin Surface Mount (50/Tube)
LCA182STR	6 Pin Surface Mount (1000/Reel)

Pin Configuration





Switching Characteristics of Normally Open (Form A) Devices







Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Blocking Voltage	350	V _P
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	Α
Input Power Dissipation ¹	150	mW
Total Power Dissipation ²	800	mW
Isolation Voltage, Input to Output	3750	V _{rms}
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

 $^1\,$ Derate linearly 1.33 mW / $^{\circ}\text{C}$

 $^2~$ Derate linearly 6.67 mW / $^\circ C$

Electrical Characteristics @ 25°C

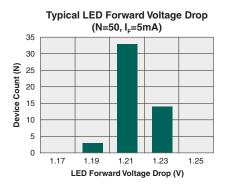
Parameter	Conditions	Symbol	Min	Тур	Max	Units
Output Characteristics						
Load Current, Continuous						
AC/DC Configuration		ΙL	-	-	120	mA _{rms} / mA _{DC}
DC Configuration	-				200	mA _{DC}
Peak Load Current	t=10ms	I _{LPK}	-	-	350	mA
On-Resistance						
AC/DC Configuration	I _L =120mA	Р		23	35	Ω
DC Configuration	I_=200mA	R _{ON}	-	7	10	52
Off-State Leakage Current	V _L =350V _P	I _{LEAK}	-	-	1	μA
Switching Speeds						
Turn-On	1 - 1mA = 1 - 10V	t _{on}		-	3	m 0
Turn-Off	I _F =1mA, V _L =10V	t _{off}	-	-	3	ms
Output Capacitance	V _L =50V, f=1MHz	C _{OUT}	-	25	-	pF
nput Characteristics						
nput Control Current to Activate 1	I _L =120mA	I _F	-	-	0.25	mA
nput Control Current to Deactivate	-	I _F	0.05	-	-	mA
Input Voltage Drop	I _F =1mA	V _F	0.9	1.2	1.4	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μΑ
Common Characteristics		<u>.</u>				
Input to Output Capacitance	-	C _{I/O}	-	3	-	pF

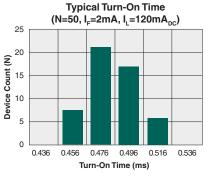
¹ It is recommended that the input control current be increased to 1mA in high temperature (>55°C) operation.

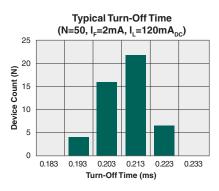


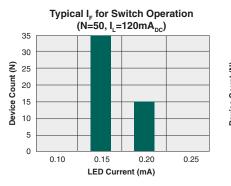
LCA182

PERFORMANCE DATA @25°C (Unless Otherwise Noted)*

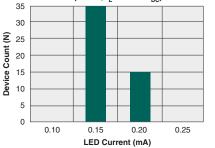




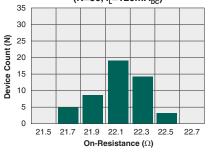


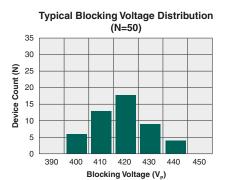


Typical I_F for Switch Dropout (N=50, I_L=120mA_{DC})



Typical On-Resistance Distribution (N=50, I, =120mA_{pc})



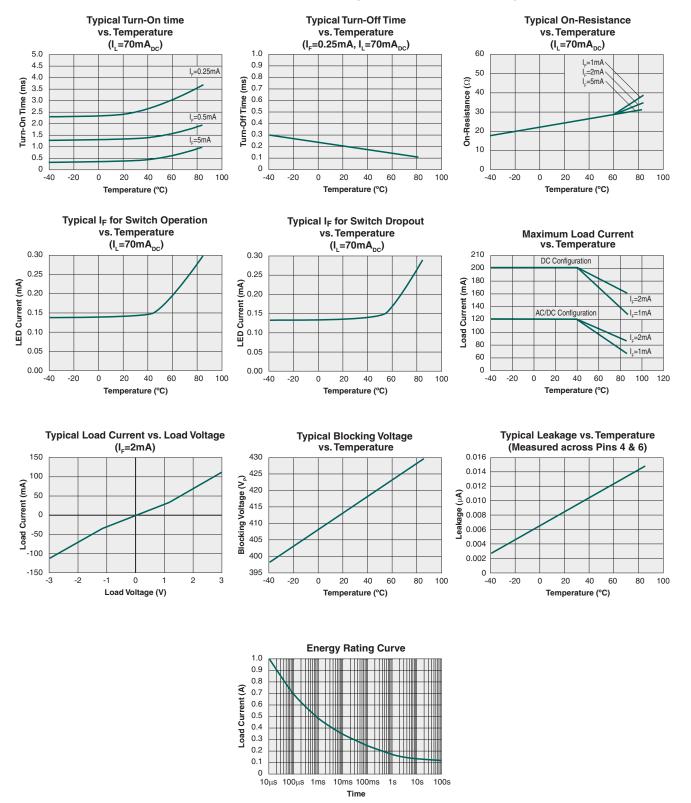


Typical Turn-On Time Typical Turn-Off Time Typical LED Forward Voltage Drop vs. LED Forward Current vs. LED Forward Current $(I_{L}=120mA_{DC})$ (I_L=120mA_{DC}) vs. Temperature 2.0 0.7 1.8 0.6 1.6 **Turn-Off Time (ms)** 0.4 0.3 0.2 Turn-On Time (ms) 1.4 1.2 I_F=50mA 1.0 0.8 I_=10mA 0.6 I_=5mA 0.4 . I_F=0.25mA 0.1 0.2 0.8 0 0 -40 -20 0 20 40 60 80 100 120 0 2 4 6 8 10 12 14 16 18 20 0 2 4 6 8 10 12 14 16 18 20 LED Forward Current (mA) LED Forward Current (mA) Temperature (°C)

*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.



PERFORMANCE DATA @25°C (Unless Otherwise Noted)*



*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.



Manufacturing Information

Moisture Sensitivity

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating	
LCA182 / LCA182S	MSL 1	

ESD Sensitivity



This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time
LCA182 / LCA182S	250°C for 30 seconds

Board Wash

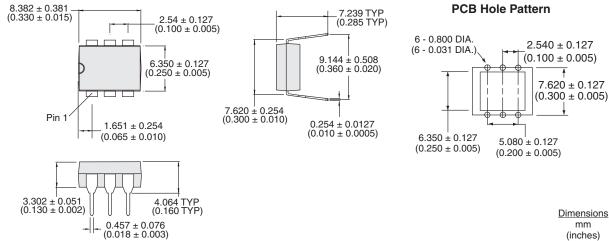
IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.





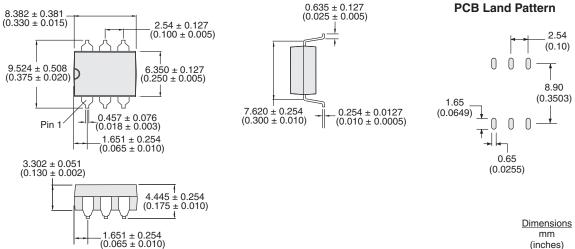
MECHANICAL DIMENSIONS

LCA182



mm (inches)

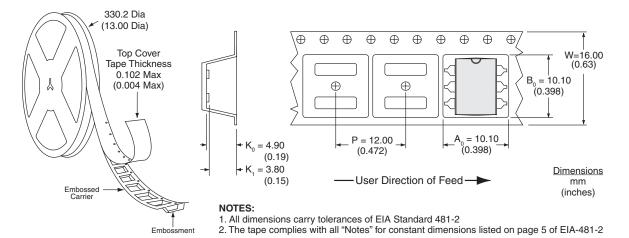
LCA182S



(inches)



LCA182STR Tape & Reel



For additional information please visit our website at: www.ixysic.com

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